



QUALCOMM Incorporated

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April 25, 2005

Via ECFS

Ms. Marlene Dortch
Secretary
Federal Communications Commission
445 12th Street, S.W.
Washington, DC 20554

Re: Oral Ex Parte Presentation in ET Docket No. 03-137

Dear Ms. Dortch:

On behalf of QUALCOMM Incorporated (“QUALCOMM”), this is to report that on April 22, 2005, Jeffrey K. Belk, Senior Vice President, Marketing, and I met with Sam Feder, Legal Advisor to Chairman Kevin Martin.

During the course of the meeting, we briefly discussed the above-referenced proceeding. I explained to Mr. Feder that QUALCOMM continues to work with laptop vendors interested in embedding modules containing EV-DO and/or UMTS/HSDPA in their products, but the Commission does not have rules governing the issuance of equipment authorizations for these devices, which would operate on PCS and cellular spectrum, and there is no threshold to permit such products to avoid having to undergo costly and time consuming SAR testing when it is not necessary. I explained further that QUALCOMM has made a proposal in the above-referenced proceeding to cure these deficiencies, which has not been opposed by any party, and adoption of QUALCOMM’s proposal would further the public interest by establishing a streamlined approval process for these products.

Finally, I provided Mr. Feder with a copy of the attached letter expressing support for QUALCOMM’s proposal from IBM. I also told Mr. Feder that HP had filed a similar letter with the Commission.

Respectfully submitted,

/s/ Dean R. Brenner

Dean R. Brenner
Senior Director, Government Affairs
QUALCOMM Incorporated

Cc: Sam Feder